PATENT

t.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Scott R. Sehlin, Vincent L. Sprenkle

Divisional of

Serial No. 09/626,794 : Group Art Unit: 1741

Filed: Herewith : Examiner: B. BELL

For: THIN FILM MODULAR ELECTROCHEMICAL APPARATUS AND METHOD OF

MANUFACTURE THEREOF

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents Washington, D. C. 20231

Sir:

Prior to examination of the above-identified application, please amend the application as follows.

IN THE TITLE

Please delete the present title and replace with the following title: --THIN FILM MODULAR ELECTROCHEMICAL PRODUCT AND METHOD OF MANUFACTURE THEREOF--.

IN THE SPECIFICATION

Please amend the specification as follows:

Page 5, second paragraph, delete in its entirety.

IN THE CLAIMS

Please cancel claims 14-20.

Please add new claims 21-55 as follows:

--21. A thin film electrochemical product manufactured according to the method, comprising:

molding a near net shape ceramic element including a planar base region and a plurality of tubular regions;

infiltrating the planar base region with a dense nonconductive material:

infiltrating each of the tubular regions with a porous conductive material;

applying a porous catalytic electrode material onto the infiltrated regions to form one of a cathodic and anodic surface;

depositing a ceramic electrolyte coating onto the porous catalytic electrode material;

applying a porous catalytic electrode material onto the deposited ceramic electrolyte coating; and

depositing a porous conductive material onto the porous catalytic electrode.

22. The product of claim 21, comprising:

subjecting the near net shape ceramic element to binder removal and sintering procedures.

23. The product of claim 21, wherein the porous conductive material has a concentration in a range between 30-50%.

- 24. The product of claim 21, further comprising forming electrically conductive vias to electrically connect a deposited porous conductive material on one of the tubular regions to an adjacent infiltrated region of another of the tubular regions.
- 25. The product of claim 24, comprising depositing a porous conductive material onto an infiltrated region and onto a portion of the planar base region.
- 26. The product of claim 25, comprising forming electrically conductive vias to electrically connect an infiltrated region of one of the tubular regions to an adjacent deposited porous conductive material of another of the tubular regions.
- 27. The product of claim 21, wherein the porous catalytic electrode material is deposited on an outer surface of each of the tubular regions.
- 28. A thin film electrochemical product manufactured according to the method, comprising:

molding a near net shape ceramic element including a base region and a plurality of tubular regions;

masking a portion of each of the base regions to form a first base region an a second base region;

depositing a porous conductive material onto the plurality of

tubular regions and the first and the second base regions;

first applying a porous catalytic electrode material onto the deposited porous conductive material to form one of a cathodic and anodic surface;

depositing a dense ceramic electrolyte onto the applied catalytic electrode material;

second applying a porous catalytic electrode material onto the deposited ceramic electrolyte to form the other one of the cathodic and anodic surface; and

depositing a porous conductive material onto the porous catalytic electrode to electrically connect the second applied catalytic electrode over the first base region to the porous conductive material on the second base region.

29. The product of claim 28, comprising:

subjecting the near net shape ceramic element to binder removal and sintering procedures.

- 30. The product of claim 29, wherein the base region includes a separate portion onto which the masking is applied.
- 31. The product of claim 28, further comprising hermetically sealing the second electrode over the second base region from the porous conductive material on the second base region.
 - 32. The product of claim 28, comprising removing the masking

between the second electrode over the second base region and the porous conductive material on the second base region.

- 33. The product of claim 28, comprising infiltrating the base region with a dense non-conductive material.
 - 34. A thin film electrochemical apparatus, comprising:
- a ceramic support structure including a non-electrolytic region and a plurality of electrolytic regions separated by said non-electrolytic region;

said non-electrolytic region being electrically non-conductive and providing an hermetic barrier;

- a first catalytic electrode layer formed on a surface of each of said electrolytic regions;
- an electrolyte layer adjacent to said first catalytic electrode layer;
- a second catalytic electrode layer adjacent to said electrolytic layer.
- 35. The thin film electrochemical apparatus of claim 34, wherein said ceramic support structure is made of aluminum oxide.
- 36. The thin film electrochemical apparatus of claim 34, wherein said electrically conductive region is approximately one-third electrically conductive material, one-third pores and one-third insulative material.

- 37. The thin film electrochemical apparatus of claim 34, wherein the catalytic electrode is ${\rm Ln_{1-x}}$ ${\rm A_x}$ ${\rm B0_3}$ where ${\rm Ln}$ is a lanthanide ion or mixture of such ions, A is Ca, Sr or Ba and B is one or more transition metal ions including one or more of Cr, Mn, Co and Ni.
- 38. The thin film electrochemical apparatus of claim 34, wherein said electrolytic layer is 95% of theoretical density.
- 39. The thin film electrochemical apparatus of claim 34, further comprising forming a plurality of electrically conductive vias in the planar base region.
- 40. The thin film electrochemical apparatus of claim 34, wherein the electrically conductive region is approximately $50\,\mu\text{m}$ thick.
- 41. A method of manufacturing a thin film electrochemical apparatus, comprising:

molding a near net shape ceramic element including a nonelectrolytic region and a plurality of electrolytic regions;

infiltrating the non-electrolytic region with a dense non-conductive material;

infiltrating each of the electrolytic regions with a porous conductive material;

applying a porous catalytic electrode material onto the infiltrated regions to form one of a cathodic and anodic surface;

depositing a ceramic electrolyte coating onto the porous catalytic electrode material;

applying a porous catalytic electrode material onto the deposited ceramic electrolyte coating; and

depositing a porous conductive material onto the porous catalytic electrode.

42. The method of claim 41, comprising:

subjecting the near net shape ceramic element to binder removal and sintering procedures.

- 43. The method of claim 41, wherein the porous conductive material has a concentration in a range between 30-50%.
- 44. The method of claim 41, further comprising forming electrically conductive vias to electrically connect a deposited porous conductive material on one of the tubular regions to an adjacent infiltrated region of another of the tubular regions.
- 45. The method of claim 41, wherein the non-electrolytic region is a planar base region and the electrolytic regions are tubular regions.
 - 46. The method of claim 44, comprising depositing a porous

conductive material onto an infiltrated region and onto a portion of the planar base region.

- 47. The method of claim 46, comprising forming electrically conductive vias to electrically connect an infiltrated region of one of the tubular regions to an adjacent deposited porous conductive material of another of the tubular regions.
- 48. The method of claim 41, wherein the porous catalytic electrode material is deposited on an outer surface of each of the tubular regions.
- 49. A method of manufacturing a thin film electrochemical apparatus, comprising:

molding a near net shape ceramic element including a nonelectrolytic region and a plurality of electrolytic regions;

masking a portion of each of the non-electrolytic regions to form a first non-electrolytic region and a second non-electrolytic region;

depositing a porous conductive material onto the plurality of electrolytic regions and the first and the second non-electrolytic regions;

first applying a porous catalytic electrode material onto the deposited porous conductive material to form one of a cathodic and anodic surface;

depositing a dense ceramic electrolyte onto the applied

catalytic electrode material;

second applying a porous catalytic electrode material onto the deposited ceramic electrolyte to form the other one of the cathodic and anodic surface; and

depositing a porous conductive material onto the porous catalytic electrode to electrically connect the second applied catalytic electrode over the first non-electrolytic region to the porous conductive material on the second non-electrolytic region.

50. The method of claim 49, comprising:

subjecting the near net shape ceramic element to binder removal and sintering procedures.

- 51. The method of claim 50, wherein the non-electrolytic region includes a separate portion onto which the masking is applied.
- 52. The method of claim 49, further comprising hermetically sealing the second electrode over the second non-electrolytic region from the porous conductive material on the second non-electrolytic region.
- 53. The method of claim 49, comprising removing the masking between the second electrode over the second non-electrolytic region and the porous conductive material on the second non-electrolytic region.

- 54. The method of claim 49, comprising infiltrating the non-electrolytic region with a dense non-conductive material.
- 55. The method of claim 42, wherein the non-electrolytic region is a planar base region and the electrolytic regions are tubular regions.--

REMARKS

Reconsideration and allowance of the subject application upon entry of this Preliminary Amendment is respectfully requested. Claims 14-20 have been cancelled and new claims 21-55 have been added. New claims 21-55 are believed to be patentable over the applied prior art.

Entry of this Preliminary Amendment is respectfully requested and deemed in order. Allowance of the application is solicited.

To the extent necessary, a petition for an extension of time under 37 C.F.R. 1.136 is hereby made. Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 07-1337 and please credit any excess fees to such deposit account.

Respectfully submitted,

LOWE HAUPTMAN GILMAN & BERNER, LLP

Kenneth M. Berner

Kenneth M. Berner Registration No. 37,093

1700 Diagonal Road, Suite 310 Alexandria, Virginia 22314 (703) 684-1111 KMB:jad

Date: December 4, 2001

Facsimile: 703-518-5499